STARPOWER

SEMICONDUCTOR

FRED

FD200CCH60D1S

Molding Type Module

600V/200A in one-package

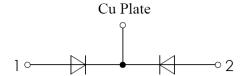


General Description

STARPOWER Diode Power Module provides low forward voltage as well as low reverse recovery loss. They are designed for the applications such as SMPS.

Features

- Fast soft diode
- Low forward voltage drop
- Small temperature coefficient
- Low reverse recovery losses
- High ruggedness
- Low inductance



Equivalent Circuit Schematic

Typical Applications

- SMPS
- PFC
- Electric welders
- DC choppers

Absolute Maximum Ratings T_C =25°C unless otherwise noted

Symbol	Description	FD200CCH60D1S	Units	
V_{RRM}	Repetitive Peak Reverse Voltage	600	V	
V_{RSM}	Non-repetitive Peak Reverse Voltage	600	V	
I_{FAV}	Average Forward Current T _C =100 °C, Diode	100	A	
	$T_{C}=100^{\circ}\mathrm{C}$, Module	200		
I_{FSM}	Surge Forward Current V _R =0V,t _p =10ms,T _j =25°C	1600	A	
	$V_{R}=0V, t_{p}=8.3 \text{ms}, T_{j}=25 ^{\circ}\text{C}$	1760		
I^2 t	I^2 t-value $V_R=0V, t_p=10$ ms, $T_j=25$ °C	12800	A^2s	
	$V_{R}=0V, t_{p}=8.3 \text{ms}, T_{j}=25 ^{\circ}C$	12907		
$P_{\rm D}$	Maximum Power Dissipation @ T _j =150°C	579	W	
T_j	Junction Temperature	-40 to +150	$^{\circ}\!\mathbb{C}$	
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\!\mathbb{C}$	
M	Terminal Connection Torque, Screw M6	3.0 to 4.7		
	Mounting Torque, Screw M4	1.0 to 1.5	N.m	
	Mounting Torque, Screw M6	3.0 to 4.7		

Electrical Characteristics of Diode T_C =25 $^{\circ}$ C unless otherwise noted

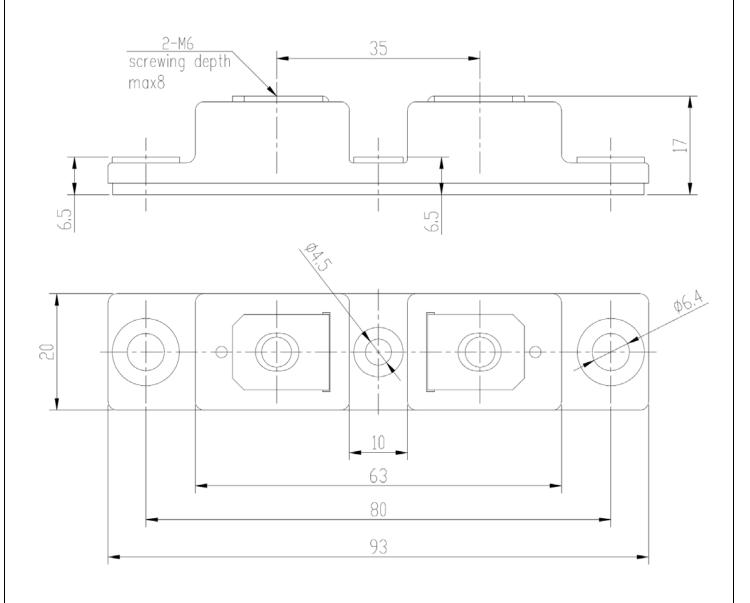
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I _F =100A	$T_i=25^{\circ}C$		1.35	1.55	V
	Voltage		T _j =125℃		1.30	1.50	V
I_R	Diode Reverse	V _R =V _{RRM}	T _j =25 ℃			0.5	mA
	Current		T _j =125℃			1.0	
t _{rr}	Reverse Recovery	$\begin{array}{c} I_F{=}100A \\ V_R{=}300V \\ di/dt{=}{-}200A/\mu s \end{array}$	T _j =25 ℃		78		ns
	Time		T _j =125℃		145		
I_{RM}	Peak Reverse		T _i =25 ℃		7.8		A
	Recovery Current		T _i =125℃		15.2		
Q_{r}	Reverse Recovery		$T_i=25^{\circ}C$		402		nC
	Charge		T _i =125℃		1150		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{ heta JC}$	Junction-to-Case		0.216	K/W
$R_{ heta CS}$	Case-to-Sink (Conductive grease applied)	0.06		K/W
Weight	Weight of Module	70		g

Package Dimensions

Dimensions in Millimeters



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